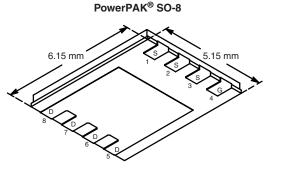


**Vishay Siliconix** 

## P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
- 30	0.0039 at V <sub>GS</sub> = - 10 V	- 60	78 nC		
	0.0062 at V <sub>GS</sub> = - 4.5 V	- 60	78110		



Bottom View

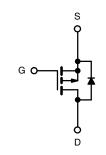
Ordering Information: Si7135DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested

#### **APPLICATIONS**

- Notebook
- Load Switch





P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>A</sub> = 25 °C, unles	ss otherwise note	ed		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V <sub>DS</sub>	- 30	V		
Gate-Source Voltage	V <sub>GS</sub>	± 20	v		
	T <sub>C</sub> = 25 °C		- 60 <sup>a</sup>		
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	- 60 <sup>a</sup>		
	T <sub>A</sub> = 25 °C	טי	- 31.6 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		- 25.3 <sup>b, c</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	- 100		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	- 60 <sup>a</sup>		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'5	- 5.6 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH		- 40		
Single Pulse Avalanche Energy	L = 0.1 mm	E <sub>AS</sub>	80	mJ	
	T <sub>C</sub> = 25 °C		104		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	PD	66.6	w	
	T <sub>A</sub> = 25 °C	' D	6.25 <sup>b, c</sup>	~~~~	
	T <sub>A</sub> = 70 °C		4.0 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature		260			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 10 s	R <sub>thJA</sub>	15	20	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R <sub>thJC</sub>	0.9	1.2	0/11	

Notes: a. Package limited.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under Steady State conditions is 54 °C/W.

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## Vishay Siliconix

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L _ 250 uA		- 31		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		6.5			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.0		- 3.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
		$V_{DS}$ = - 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			- 10	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 V, V_{GS} = -10 V$	- 30			Α	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 20 A		0.0032	0.0039	Ω	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 15 A		0.005	0.0062		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 20 A		95		S	
Dynamic <sup>b</sup>				<b></b>	<u>1</u>	1	
Input Capacitance	C <sub>iss</sub>			8650		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1215			
Reverse Transfer Capacitance	C <sub>rss</sub>			1125			
Total Gate Charge	Qg	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 20 A		167	250	nC	
		V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 20 A		78	120		
Gate-Source Charge	Q <sub>gs</sub>			27			
Gate-Drain Charge	Q <sub>gd</sub>			35			
Gate Resistance	Rg	f = 1 MHz		1.7		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			25	40	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 15 $\Omega$		15	30		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D$ $\cong$ - 1.0 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		110	170		
Fall Time	t <sub>f</sub>			30	50		
Turn-On Delay Time	t <sub>d(on)</sub>			110	170		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 15 $\Omega$		100	150		
Turn-Off Delay Time	t <sub>d(off)</sub>	${\rm I_D}\cong$ - 1.0 A, ${\rm V_{GEN}}$ = - 4.5 V, ${\rm R_g}$ = 1 $\Omega$		100	150		
Fall Time	t <sub>f</sub>			50	75		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C			60	٨	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				100	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 5 A		- 0.74	- 1.1	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	100	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 2.5 A dt/dt = 100 A/tra T = 05.00		65	130	nC	
Reverse Recovery Fall Time	ta	$I_F = 3.5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		26			
Reverse Recovery Rise Time	t <sub>b</sub>	t <sub>b</sub>		24	1	ns	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



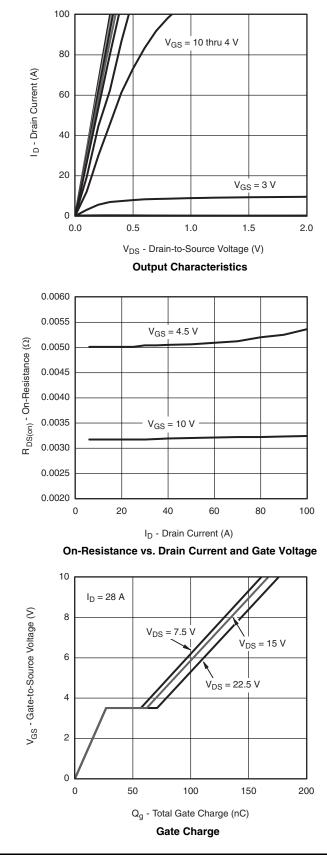
1.2

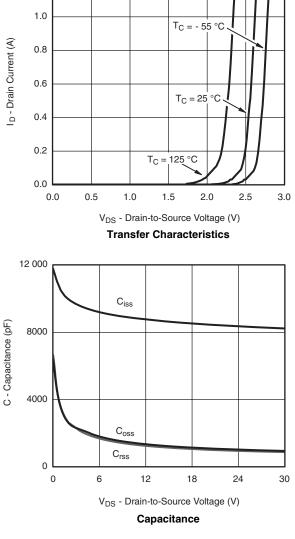


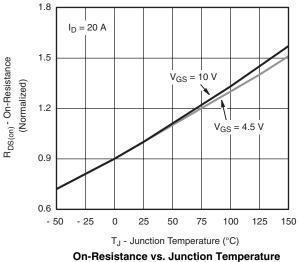
## Si7135DP

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





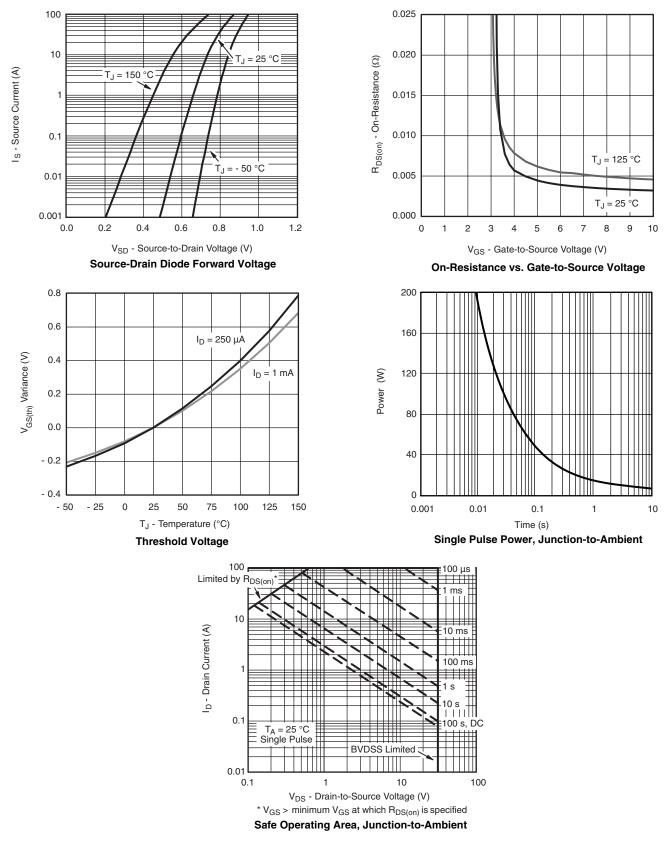


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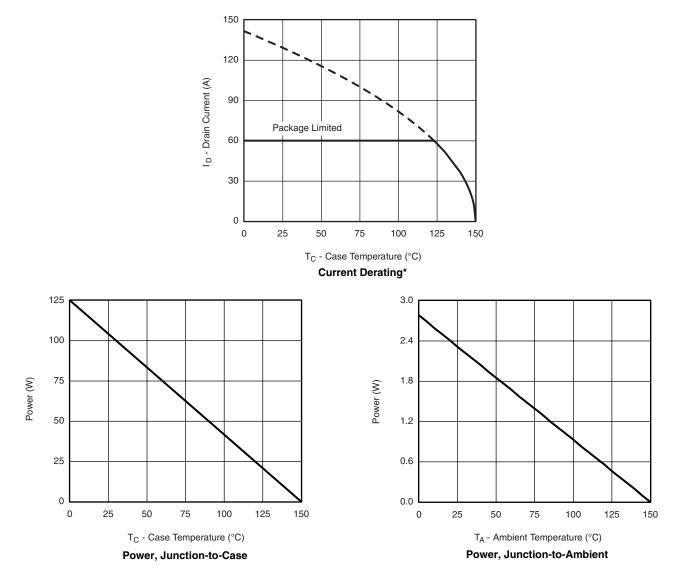
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### Si7135DP Vishay Siliconix

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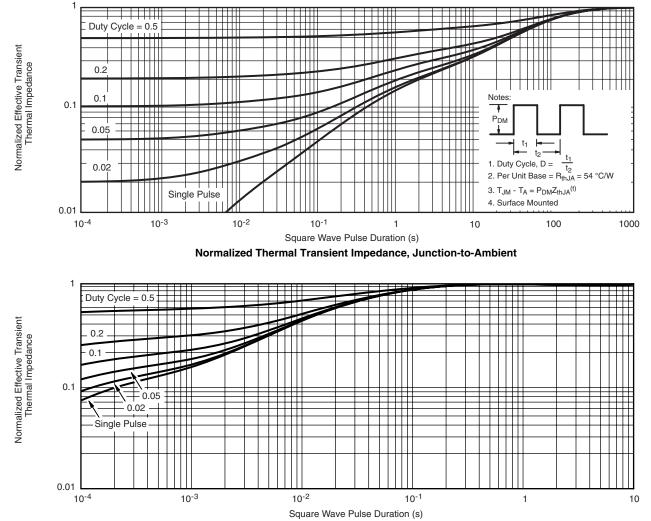


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### **Vishay Siliconix**

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68807.



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